

# PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Wei qi WANG	11/27/2009
Tetsuya IKEMOTO	11/27/2009
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SUMITOMO CHEMICAL COMPANY, LIMITED
<b>Street Address:</b>	27-1, Shinkawa 2-chome
<b>City:</b>	Chuo-ku, Tokyo
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	104-8260
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12667654
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<b>Total Attachments: 1</b> source=ASSIGNMENT_AS_FILED#page1.tif	

CH \$40.00 12667654

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**PATENT**  
**REEL: 023736 FRAME: 0049**

**ASSIGNMENT**

Whereas, I/we,

NameAddress1) **Weiqli WANG**9-6-4-205, Hon-machi,  
Toyonaka-shi, Osaka 560-0021 Japan2) **Tetsuya IKEMOTO**1-2-9-501, Chokojiminami,  
Toyonaka-shi, Osaka 561-0874 Japan

hereinafter called assignor(s), have invented certain improvements in  
**PROCESS FOR PRODUCING TRANS-DIBENZOXENOPYRROLE COMPOUND AND INTERMEDIATE THEREFOR**

and executed an application for Letters Patent of the United States of America therefor on even date herewith unless  
otherwise indicated below:

filed on 01/04/2010Serial No. 12/667,654

; and

Whereas

**SUMITOMO CHEMICAL COMPANY, LIMITED**27-1, Shinkawa 2-chome,  
Chuo-ku, Tokyo 104-8260 Japan

(assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States  
patents to be obtained therefor;

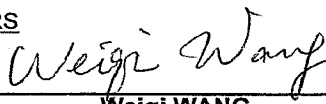
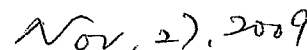
NOW THEREFORE, be it known that, for good and valuable consideration from assignee, the receipt of which is  
hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign,  
transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to  
this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States  
which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of  
Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and  
assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with  
assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal  
proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or  
desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional,  
continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its  
successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being  
understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and  
assigns.

INVENTORSDATE SIGNED

1):

Name:

**Weiqli WANG**

2):

Name:

**Tetsuya IKEMOTO**